Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	1262	"257"/$.ccls. and (redistribut$4 rerout$3 trace) with (die ic die) same wire and (board carrier substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:35
L4	999	"257"/$.ccls. and (redistribut$4 rerout$3 trace) with (die ic die) same wire same (board carrier substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:38
L5	244	"257"/$.ccls. and (redistribut$4 rerout$3 trace) adj4 (die ic die) same wire same (board carrier substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:42
L6	10	"257"/$.ccls. and (redistribut$4 rerout$3) adj5 wire with (die ic die) same (board carrier substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:42
L7	20	"257"/$.ccls. and (redistribut$4 rerout$3) adj5 wire with (die ic die) and (board carrier substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:45
L8	31	(redistribut$4 rerout$3) adj5 wire with (die ic die) and (board carrier substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:48
L9	332	trace adj5 wire with (die ic die) and (board carrier substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:59
L10	486	257/776 and wire	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 22:59
L11	347	257/776 and wire same (chip die ic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 23:23

L19	29	257/776 and wire with (intermediate middle jumper) same (chip die ic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 23:26
L20	121	257/784 and wire with (intermediate middle jumper) same (chip die ic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 23:31
L21	297	"438"/$.ccls. and wire with (intermediate middle jumper) same (chip die ic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/30 23:32